L Number		dearch Text 1945969.pn.	DB USPAT; US-PGFUA; EPO; JF J; IBM TUR	Time stamp 11884/7/17 11:25
-	-	5945969.pn. and Srame	USPĀT; US-PGPUB; EPO; JPO;	2003-07-17-11:25
13	-	(945969.pm. and Support	IBM TOB USPĀT; US-PGPUB; EP ; JPO; IBM TOB	\$003%17%17 11:26
29	ŷ.	8948969.pn. and joint frit	USEAT; US-PGPUB; EP.; JPO;	2003/17/17 11:27
25	•	5945969.pn. and 'edge	IBM_TOB USPAT; US-PGPUB; EP ; JPG; IBM TDB	2003/07/17 11:27
31		ands-yoichi.in. and emitter	US:AT; US PGPUB; EF; JPO; DEFWENT; IBM TOB	2003/07/27 11:47
3 8	5	ando-yoichi.in. and emitter and surround\$4 encircl\$4 circl\$4	USFAT; USFPGPUB; EF'; JPO; DEFWENT; IBM TDB	2003/07/17 11:47
4 5	5	ando-yoichi.in. and emitter and (surround\$4 ensire1\$4 pirs1\$4)	USFAT; US-PGPUB; EB'; UPO; DEFWENT; IBM TOB	2003/07/17 11:50
52	8	<pre>(ando-yoichi.in. and emitter) not (ando-yoichi.in. and emitter and (surround\$4 encircl\$4 circl\$4))</pre>	US:AT; US-PGPUB; EPr; JPO; DERWENT; IBM: TDB	2003/07/17 11:50
141	2	6509691.pm.	US:AT; US:PGPUB; EPH; JPC; IBM TDB	2003/07/17 12:12
147	0	6509691.pn. and (surroundS5).clm.	US: AT; US-PGPUH; EFH; JPO; IEM TDB	2003/07/17 12:12
153	0	6509691.pn. and (encircl\$4 direl\$4).plm.		2003/07/17 12:14
165	:	20030102798.did. and (surround84 encircl84 circl84 .clm.		2003/07/17 12:14
159	1	20030102799.did.	US: AT; US PGPUB; EFO; JPO; IBM TOR	2003/01/17/13:20
171		20030102798.did. and surround\$4	USPAT; US-EGEUB; EFT; JEG; IBM TOB	2003-657/17 12:45
1***	:	01000102799.did. and apart from	usiāt; us-papub; epa; upo; ibii_tub	2003./m/in/ta:59

ju a	1 59.3108.pn. and "33"	USPAT; DITES INVITO 12:89 US-EGRUP; EPO; NE ;
1ĕ\$	1 5903108.pn.	IBM TIB IBM TIB USPAT; 1033/17/17 13:15 USPOGEUB; EPO; UPO;
195	191 serigraphy	IBM_TOB USPAT; ZIMBONT 17 19:18 US-PGPUB; EPO; JPO;
2.2	0 20030102798.did. and second awg conduc adf film	IBM_TOB ctive OSFAT; 2003/17/17 13:11 US-PSPUR; EP:; JPD;
2.77	1 20030102798.did. and "14"	IBM_TOB USPAT; 2003/90/17 13:20 US-PGPUB; EBU; CPD;
213	1 20020005692.did.	IBM_TOB USPAT; 2003/07/17 13:21 US-PSPUB; EPU; JPD;
219	1 20020008692.did. and second adj conduct adj film	US-PSPUB; EFU; CPD;
-	905 (313/495).ccls.	IEM_TDB USEAT; 2003/07/17 11:24
-	109 ando-yoichi.in.	US-PSPUE US:AT; 2003/07/16 12:45 US-PSPUE; EED; JPU;
-	2 hyperspeed.ti.	DEFWENT; IE::_TDB USFAT; 2003/01/30 15:32 US-PGEUF; EFF; CEC; DEFWENT;
-	1 lightspeed.ti.	IBM_TDB USFAT; 2003/01/30 15:33 US-PGPUF; BEL; JEC;
-	13 hyper same antenna.ti.	DEFWENT; IBM_TDF US:AT; 2003/01/30/15:33 US-PGPUE; EF7; CF0;
-	32 ando-yolohi.in. and image adj forming	DEFWENT; IBM_TDB US:AT; 2003/07/17 11:46 US-PGPUB; EPc; UFC;
-	984 - 313 4951.CCLS.	DEFWENT; IBM_TDB USPAT; 2003/01/31/09:41 US-FGFUE; EPO; JEO;
_	905 (312 495 .CCt2.	DERWENT; IBM_TDB
_	- 300 (313 496).ccus.	USPĀT; 2003×01×31 09:42 US-PSPUR USPAT; 2003/01/31 11:28
_	0 - "114 not 115" .FN.	USPAT; 2003/01/31 11:28 USPAT; 2003/01/31 19:42
~	444 "114" mat	US-EGEUB
		USPAT; 2003 NO 31 N9:42 US-EGEUB; EFO; JED; DERWENT; JEM_TOB

-	2.7.7 2.1.1	913 496 .00L8. not 318 495 .00L8.	USPAT; US-ESPUB; EPO; JPO;	1 03 21 31 20:47
-	2	8%13108.pm.	DERWENT; IBM_TOB USPAT;	21.3%11 31 11:16
			US-PGPUR; EP(); JPO; DEFWENT; IBM TOB	
- -	-	%.knas.ursu. pimtech.as.	USFĀT USPAT;	2013/01/31 10:40 2013/01/31 11:01
			US-PGPUB; EPC; JPC; DEFWENT;	
_	209279	5903108.pn. spacer	IBM_TOB USFAF;	2003/01/31 11:06
			US-PGPUB; EP#; JP1; DERWENT;	22,73
-	-	5903109.pn. and spacer	IBM_TDB US:AT; US-PGFUB; BB%; JPD;	2003/01/31 11:16
			DERWENT; IBM_TDB	
-	0	5463276.pn. and image	USEAT; US-PGPUP; EF ; SPC; DEFWENT;	2003/01/31 11:16
-	Ž.	5463276.pn. 4899081.pn.5270613.pn. and	IEM_TDB USFAT;	2003/01/31 11:17
		image	US-PGEUÐ; EFG; JPG; Dæðwent;	
-	:	(5463276.pn. 4899081.pn. 5270613.pn.) and image	IBM_TOB USEAT; USEAGEUE; EEG; GPG; DEFWENT;	2003/01/31 11:17
-	1105	((313/496) or (313/495!).ccls.	IEM_TEB USEAT;	2003/01/31 11:29
_		(313/493).CCLs.	U3-FGEUE U3EAT;	2003.01/31 11:28
_		v"199 not 195").EN.	US-PGFUE USEAT;	2003/01/31 11:25
_		((313/493).CCLS.) not (((313/496) or	US-PGPUB USFAT;	
	. 27	(313/495)).CCLS.)	US-PGEUB; EEC; JPC; DEFWENT; IBM TDB	2003,01/31 11.30
_	193	(((313/493).CCLS." not (,,313/496) or (,313/495)).CCLS." and display	USPĀT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/31 11:30
-	30	. 313-493 .CCLS. not 313 49% or .313,495% .CCLS. and display and image	IBM_TDB USFAT; US-PSFUB; RPO; JPO; DERWENT;	0003/01/31/11:37
-	agg	-313-63430LS.	IBM_TOB USPAT; US-PGPUB	2.223/21 31 11:45
-	8	."5508584" "5543691" "5561345" "5614781" "5677296" .EM.	USPAT	2/03/61/31 11:37
-	1431	990310910990. - 313 493 or 314 495 or	USPAT USPAT;	1003 31 31 11:40 8803 11 31 11:43
-		313 496: .00LS. "1135 mat 1130":.pw.	US-FIFUR	2703/01/81/11:48
			US-FGFUB	en en al composition and the state of the st

-	Tue 313 634 .37121. http://doi.org/ 313 435 tr 413 494 .17121.	USPAT;
		CERWENT; IBM TDB
-	46 ' 313:634 .7712. n.t 913 493 or 313:496 or 313:496 .7713. and image and forming display	EPO; JPO; DERWENT;
-	1708 - 313-498 c: 313-490 %: 1313/493 7.0018.	IBM_TOB C.PAT ZUČŠAUTYLE 15:25
-	111 313 495 or 313 494 er 313 493 .0013.	t/-PGPUB 1003=17v16 13:14
-	1 5770 918.pm.	UUPAT; 2603/67/16 15:26 UU-PSPUB; EIO; JPO;
-	1 6000918.pm. and 403b	IBM_TDB UUPAT;
_	1 6114684.pm.	<pre>HHM_TDB UUPAT; 2003/00/16 15:31 UU-PGPUB; BEO; JPO;</pre>
-	1 6114834.pn. and "14"	<pre>IBM_TOB OUTAT;</pre>
-	1 20020005692.did.	UNFAT; 2003/07/16 19:19 UNFPGPUB; EFO; JPO; IFM TOB
-	0 20020005692.did. and conductive adj layer	U.: AT; 2003/07/16 15:40 U.: PGPUB; EFC; JPD; IFM TDB
-	1 20020005692.did. and conductive adj film	
-	<pre>1 20020005692.did. and conductive add film near4 "5"</pre>	Un:AT; 2003/07/16 15:58 U:-PGPUE; EIC; JPC; IMM TDB
-	1 5903108.pm.	OFFAT; 2003/00/16 15:47 UN-PGPUE; EPG; JPG; IBM TDB
-	1 5903108.ph. and spacer	UNFAT; 2003/07/16 15:47 UN-PGPUE; EPO; JPO; IBM TDB
-	1 20020005692.did. and conductive adj film near4 "14"	USEAT; 2003/07k16 16:15 USE PGPUB; EPC; UPO; IBM TOB
-	1 5903108.pm.	OPPAT; 2003/07/16 16:15 UP-PGPUB; BRC; CFC; IBM TDB
-	1 5903129.pn. and track	USPAT; CACSYCTY16 16:18 US-EGRUB; BFC; CEC; IBM TDB
-	1 5903106.pm. and track rim; with materia	1 UNPAT: COMBINE 14:33 UN-PREVE; BEC; CEO; DEM_TUB

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-	:	20120005690.dtil. and 205	USPAT; US-MSPUH; EPO; UP.;	103.17/18 16:33
-	-	200200,8890.drd. and langitudinal	IBM_TOB USFAT; US-PGPUB; EPO; JPO;	2003 - Tric le:34
-	-	20020008691.did. and longitudinal with end same discharge	US-PGPUB; RP1; JP0;	2003-07/18 16:35
•	*	20020005692.did. and longitudinal with end same suppressing	IBM_TOB USPAT; US-PGPUB; EF0; UP0;	2003/07/16 16:36
-	-	20020008890.did. and longitudinal with end	US-PGPUH; EPH; JPC;	2003/17/06/19:06
-	*	20020005692.did. and conductive adj film with "5" same surface	IBM_TDB US:AT; US-PGPUF; EP; JPO;	2003/07/16 17:19
-	1	5983108.pm. and spacer	IBM_TDB US:AT; US-PGPUF; EP+; JPG; IBM_TDB	2003/07/16 17:23
-	:	5903108.pn. and Gring track, same 'film coat\$ layer\$4)	USFAT; US PSPUL; EEL; UPO; IBM IDB	2003/07/16 17:30
-	5	5903108.pn. and (closed adj loop)	USFAT; US-PGEUB; EBT; UPO; IBM TEB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4	US: AT; US-PGEUB; EFT; CPC; IBM TEB	2003/07/16 17:34
-	:	5903109.pn. and bias\$4 same (track ring)	USFAT; US-PGEUF; ES:; JFC;	2003/07/16 17:36
-		5903109.pn. and bias\$4 same track ring" same cathode	IEM_TDB US:AT; US-PGPUB; EPG; JPG;	2003/37/16 19:06
	79	jones-gary-w.in.	IEM_TOB USFAT; US-PGPUB; EFC; JPO;	2003/07/16 18:07
-	34	jones-gary-w.in. and zimmerman-steven-m.in.	IBM_TDB USFAT; US-PGPUB; EFF; JPO;	2003 07/18 18:07
-	:	6169359.pm.	IBM_TDB US:AT; US-PGPUB; EPH; JPC;	2003/07/18/18:07
-	:	6169358.pn. and "340"	IBM_TOB USLAT; US-EGEUB; EPO; JPO; IBM_TOB	
-		2/20000000000.did. did "14"	TBA TOB TSPAT; TSPESPUB; EPO; JEO; IBM_TDB	2013 07 1H 19:18
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-	:	$20000108690. \mbox{did.}$ and second udf conductive and tilm	TGFAT; US-PAPUB; EFC; IFC; IBM_TIB	2119 în la le:Be
_		59331.8.VRHN.	USPĀT	2013/07/16 14:56
-		anode same surround ring entirale sirale and image display panel	USPAT; US-PGPUB; EPG; UPG; IBM TOB	2008 kinkila 14169
-	1	surroundSS ring ensirgle sirclS4 with image with display panel same sonductive metallic near3 sfilm coat layer and substrate	USPAT; US-PGFUB; EFC; JPO; IBM TDB	2003/00/16 19:15
-	-	surround@0 ring endirale diral@4 with @image with (display panel), same conducting conductive metallic near? @film_coat_layer, and substrate	USPAT; USAPGPUB; EPO; JPO; IBM TOB	2003/27 18 19:01
-	17	('surround\$5 ring entircle bircl\$4' with image with 'display panel same conducting conductive metallic, near3 film coat layer and substrate and surround\$5 ring entircle bircl\$4, with image with 'display panel's same (film coat layer)	USPAT; US-PGPUB; EFG; JPC; IBM_TCB	2003/07/16 19:14
-		(surround\$5 ring entirale birol\$4 with (anode electrode, same conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image, ab, ti.	USPAT; US-PGPUE; EPO; JPC; IBM_TDB	2003/09/16 19:17
		(sirround\$5 ring endirole dirol\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film toat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$6 ring endirole dirol\$4) with (image with display panel)) same (conducting conductive metallic) near3 (film toat layer) and substrate) and (surround\$5 ring endirole dirol\$4) with (image with display panel)) same (conducting conductive metallic) near3 (film doat layer);	USFAT; US-PGPUB; EPG; JPC; IBM_TDB	2003/07/16 19:20
	60	(surround\$5 ring encircle circl\$4' near4 (phosphor an;de electrode; with (conducting conductive metallic) near3 (film coat layer) and ((surround\$5 ring encircle cir:l\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image'.sb,ti. not ; surround\$5 ring encircle cir:l\$4; with (image with (display panel) same conducting conductive metallic near3 film coat layer) and substrate) and (surround\$5 ring encircle circl\$4' with image with (display panel) same (conducting conductive metallic) near3 film coat layer) and substrate) and (surround\$5 ring encircle circl\$4' with image with (display panel) same (conducting conductive metallic) near3 film coat layer	USFAT; US-PGPUE; EPG; JPO; IBM_TDB	2003/07/16 19:21

	surround@5 ring entircle circl@4 near4 phosphor ancie electrode near4 phosphor with bonducting cinductive metallic near% 'film doat layer and 'surround@5 ring endircle direl@4 near4 phosphor ancde electrode with 'conducting conductive metallic near3 'film doat layer and substrate and image and 'display panel image .ab,ti. not 'o'surround@5 ring endircle direl@4 with 'image with display panel' same 'conducting conductive metallic near3 film doat layer' and substrate and 'surround@5 ring endircle direl@4, with 'image with 'display panel, same 'conducting conductive metallic near3 'film coat layer'	MS-EGETH; EFC; JPD;	2013 17 16 19479
-	14 *surround\$5 ring encircle circl\$4 near4 'phosphor anode ,electrode near4 phosphor'' with "conducting conductive	US-PGPUB;	2003/07/16 19:24
	(surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor); with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not [(surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPG; JPG; IBM_TDB	2003/07/16 19:25
	(surround\$5 ring encircle circl\$4) near4 (phosphor ancde (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and ((surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor): with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).sb,ti. not ((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)	USPAT; US-PGPUB; EFO; JPO; IBM_TDB	2003/07/16 19:46
- 1	layer:: Diguard adj ring nearé anode	USFAT; US-POPUB; EPO; UPO; IBM TOB	2013+07 18 19:47
-	guard adf ring neath angle uni image and display panel .ab,ti.	USFAT; USFEREUB; EPO; JEO; IBM_TOB	2018 în 18 19:40

l quard aug ring nearl3 ancd> and image and USPAT;
-display panel lab, ii. US-F3FUB;
EF3; J10;
IBM_T1B

2.33 (7:16 19:47